



Intel® 31154 133MHz PCI Bridge

Datasheet

Product Features

<ul style="list-style-type: none">■ PCI Bus Interfaces■ <i>PCI Local Bus Specification</i>, Revision 2.3 compliant■ <i>PCI-to-PCI Bridge Architecture Specification</i>, Revision 1.1 compliant■ <i>PCI Bus Power Management Interface Specification</i>, Revision 1.1 compliant■ <i>PCI-X Addendum to the PCI Local Bus Specification</i>, Revision 1.0a compliant■ Masquerade Mode■ Message Signal Interrupt (MSI) support■ External SROM support■ Vital Products Data (VPD) support■ Subsystem ID/Subsystem Vendor ID ECR support■ <i>Compact PCI Hot Swap Specification</i>, Revision 2.1 Support■ HW Support for Compact PCI (cPCI) Redundant System Slot configured platforms■ 64-bit Initiator/Target Capable■ 64-bit addressing	<ul style="list-style-type: none">■ Asynchronous cflocking in PCI mode■ Secondary Bus Arbitration■ Internal Arbiter Supports nine agents in addition to VerrazanoX■ Internal Arbitration can be disabled■ Optimized for PCI-X R1.0a mode■ Bus parking on bridge or last master■ Improved Buffer Architecture■ 8K Byte Data Buffers in each direction■ Improved level of Concurrency■ Up to nine outstanding transactions on each bus■ Scalability/Flexibility■ PCI R2.3 32/64-bit 33/66 MHz, 3.3 V■ 5 V Tolerant■ PCI-X R1.0a 32/64-bit 66/100/133 MHz, 3.3 V■ JTAG Interface■ GPIO Interface■ Allows simple software-controlled signaling protocols
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Revision History

Date	Revision	Description
May 2003	001	Initial release
August 2003	002	updated document title; corrected ballmap
January 2004	003	updated Section 3.4

Introduction

1.1 About This Document

This document provides information on the Intel® 31154 133MHz PCI Bridge, including a functional overview, mechanical data, package signal location and bus functional waveforms.

1.2 Product Overview

The Intel® 31154 133MHz PCI Bridge (also called 31154 Bridge) is a PCI component that functions as a highly concurrent, low latency transparent bridge between two PCI busses. The 31154 Bridge is capable of operating as a PCI-to-PCI bridge in the configurations shown in [Table 1](#).

The 31154 Bridge is used on motherboards to provide additional I/O expansion slots. It is also used on PCI add-in cards as a means of mitigating the restrictive electrical loading constraints imposed on an expansion slot, enabling multiple conventional PCI or multiple PCI-X devices to reside on a single PCI I/O adapter.

The 31154 Bridge has additional hardware support for Compact PCI Hot Swap and Redundant System Slot via queue flush, arbiter lock, and clock output tri-stating.

The 31154 Bridge supports any combination of 32- and 64-bit data transfers on its primary and secondary bus interfaces. The bridge is 33/66 MHz capable in conventional PCI mode, and can run at 66 MHz, 100 MHz, or 133 MHz when operating in PCI-X mode depending upon its surrounding environment.

Table 1. PCI to PCI Bridge Configurations

Primary Bus Interface	Secondary Bus Interface
PCI Local Bus Specification, Revision 2.3	PCI Local Bus Specification, Revision 2.3
PCI Local Bus Specification, Revision 2.3	PCI-X Addendum to the PCI Local Bus Specification, Revision 1.0b
PCI-X Addendum to the PCI Local Bus Specification, Revision 1.0b	PCI Local Bus Specification, Revision 2.3
PCI-X Addendum to the PCI Local Bus Specification, Revision 1.0b	PCI-X Addendum to the PCI Local Bus Specification, Revision 1.0b

The 31154 Bridge is offered in a 421-lead PBGA package. This package is shown in [Figure 1](#).

[Figure 2](#) shows the left side of the 31154 Bridge ball map. [Figure 3](#) shows the right side of the ball map.

Figure 1. 31154 Bridge Assembly Drawing

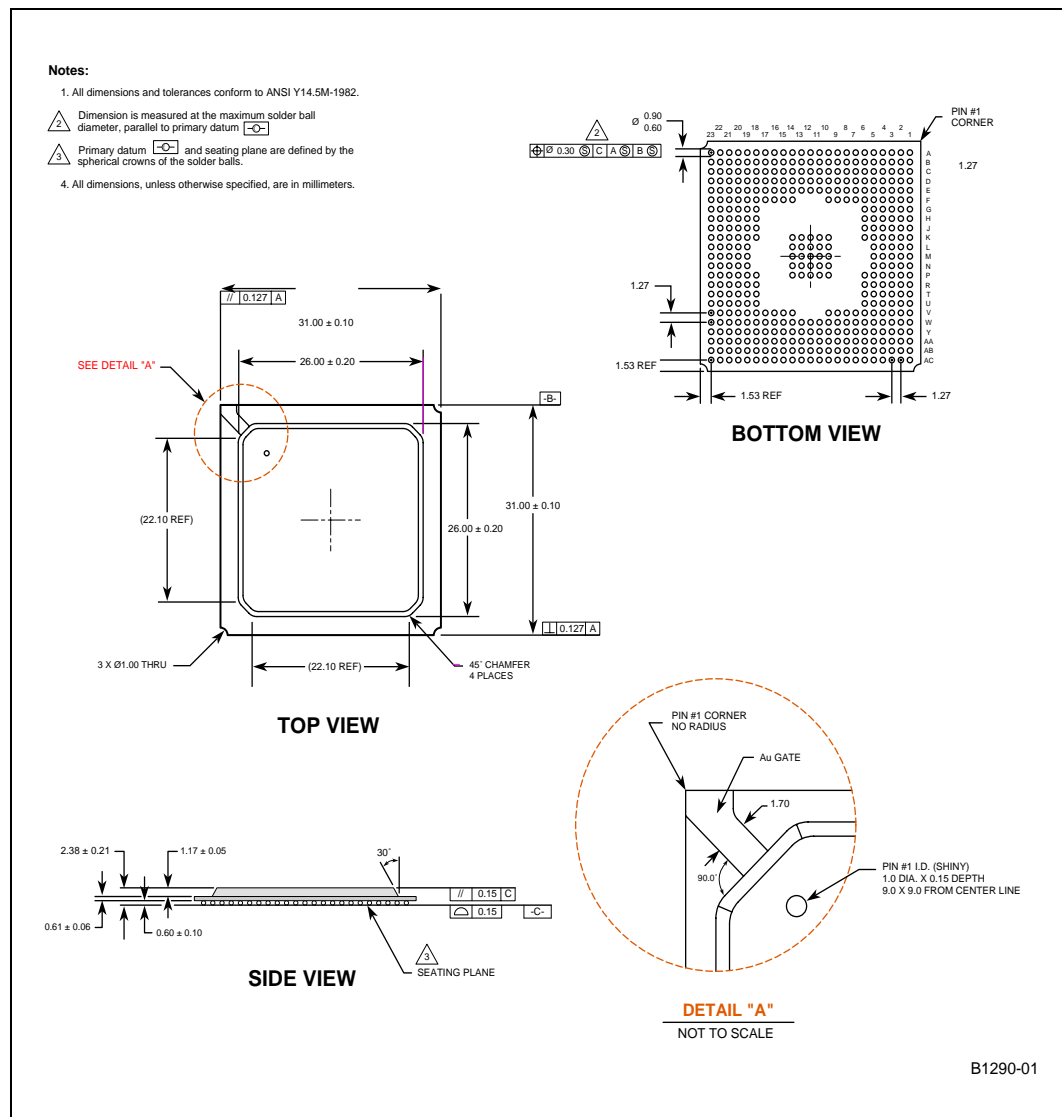


Figure 2. 31154 Bridge Ball Map – Left Side

	1	2	3	4	5	6	7	8	9	10	11	12
A	VSS	P_AD64#	P_AD56	P_AD60	P_CBE4#	VSS	P_CBE7#	VCCP	P_PAR64	VSS	VSS	VCCP
B	P_AD43	VSS	P_AD54	P_SERR#	P_AD49	P_AD50	P_AD52	P_AD55	P_AD57	P_AD59	P_AD63	P_CBE6#
C	SCAN_EN	P_AD48	VSS	P_STOP#	VCCP	S_CLK_OEN3	P_AD53	P_PERR#	P_AD58	P_AD61	P_CBE5#	P_REQ64#
D	S_CLK_OEN2	P_AD47	QE	VSS	VCCP	P_AD51	VCCP	VSS	VCC	P_AD62	VCC	VSS
E	P_AD38	S_CLK_OEN1	P_AD45	VCCP	R_REF	VSS	HS_LED_OUT	HS_LSTAT	HS_ENUM#	VSS	S_TRI_STATE	HS_FREQ0
F	VSS	P_AD42	P_AD44	P_AD46	VSS	VCC	VSS	VCC	VSS	VCC		
G	P_AD36	S_CLK_OEN0	P_AD41	VCCP	HS_SM	VSS						
H	P_AD35	P_AD39	P_AD40	VSS	P_M66EN	VCC						
J	P_AD33	P_AD34	P_AD37	VCC	SR_CLK	VSS						
K	VSS	S_AD34	S_AD33	S_AD32	VSS	VCC				VSS	VSS	VSS
L	P_AD32	S_AD36	S_AD35	VCC	SR_CS					VSS	VSS	VSS
M	VCCP	S_AD39	S_AD38	VSS	SR_DO					VSS	VSS	VSS
N	VSS	S_AD41	S_AD40	VCC	SR_DI					VSS	VSS	VSS
P	VSS	S_AD47	S_AD45	S_AD43	VSS	VSS				VSS	VSS	VSS
R	S_AD37	S_AD49	S_AD48	VCC	S_GNT7#	VCC						
T	S_VIO	S_AD51	S_AD50	VSS	S_REQ7#	VSS						
U	S_AD42	S_AD53	S_AD52	VCCP	S_GNT6#	VCC						
V	VSS	S_AD55	S_MAX100	S_AD54	VSS	VSS	VCC	VSS	VCC	VSS		
W	S_AD44	S_REQ2#	S_CLK_STABLE	VCCP	S_REQ6#	VSS	VSS	VSS	VSS	VSS	VSS	VSS
Y	S_AD46	S_GNT2#	S_AD56	VSS	VCCP	S_AD57	VCCP	VSS	VCC	S_CBE7#	VCC	VSS
AA	NC	S_REQ1#	VSS	TMODE2	S_AD58	S_AD59	S_AD61	S_ACK64#	S_AD00	S_PAR64	S_CBE5#	S_AD06
AB	S_GNT1#	VSS	S_REQ3#	S_GNT4#	S_REQ4#	S_AD60	S_AD62	S_AD63	S_AD01	S_CBE6#	S_AD04	S_CBE0#
AC	VSS	VCCP	S_REQ5#	S_GNT5#	S_GNT3#	VSS	CRS_TEN	S_CBE4#	S_AD02	VSS	S_AD03	VCCP
	1	2	3	4	5	6	7	8	9	10	11	12

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Figure 3. 31154 Bridge Ball Map – Right Side

	13	14	15	16	17	18	19	20	21	22	23	
A	P_CBE0#	VSS	P_CBE3#	P_IRDY#	P_FRAME#	VSS	P_AD04	P_AD07	P_VCCA	VCCP	VSS	
B	P_AD00	P_AD02	P_TRDY#	P_AD05	P_AD08	P_CBE1#	P_IDSEL	P_AD15	P_REQ#	VSS	TDO	
C	P_AD01	MT0#	P_AD03	P_AD06	P_AD09	P_PAR	P_AD10	P_GNT#	VSS	TDI	TRST#	
D	VCC	P_CBE2#	VCC	VSS	VCCP	P_AD11	VCCP	VSS	P_DEVSEL#	TMS	P_AD22	
E	HS_FREQ1	VSS	NT_MASK#	GPIO0	GPIO1	VSS	GPIO2	VCCP	P_CLK	P_RST#	P_AD24	
F		VSS	VCC	VSS	VCC	VSS	VSS	P_AD13	TCK	P_AD12	VSS	
G						VCC	VSS	VCCP	P_AD16	P_AD14	P_AD26	
H						VSS	VCC	VSS	P_AD18	P_AD17	P_VIO	
J						S_CLKO0	S_CLKO2	VCC	P_AD20	P_AD19	P_AD31	
K						S_CLKO1	S_CLKO4	P_AD25	P_AD23	P_AD21	VSS	
L							S_CLKO3	VCC	P_AD28	P_AD27	VSS	
M							S_CLKO5	VSS	P_AD30	P_AD29	S_AD27	
N							S_CLKO6	VCC	S_AD30	S_AD31	S_AD25	
P						S_BRG_CLKO	S_CLKO7	S_AD26	S_AD28	S_AD29	VSS	
R						S_M66EN	S_CLKO8	VCC	S_AD22	S_AD24	S_PCIX_CAP	
T						VCC	VCC	VSS	S_ARB_DISABLE	S_AD20	S_AD23	
U						VSS	S_GCLK_OEN	VCCP	S_AD18	S_AD19	S_RST#	
V		VCC	GPIO3	GPIO5	S_GNT8#	VCC	VSS	S_AD14	S_AD16	S_AD17	VSS	
W	VCC	VSS	S_REQ8#	GPIO4	GPIO6	GPIO7	VSS	VCCP	S_AD15	TMODE_0	S_AD21	
Y	VCC	S_TRDY#	VCC	VSS	VCCP	S_AD11	VCCP	VSS	TMODE_1	DEV_64BIT#	TMODE_3	
AA	S_AD07	S_FRAME#	S_CBE3#	S_AD10	S_PAR	OPAQUE_EN	S_GNT0#	S_AD13	VSS	RSRV0	S_REQ0#	
AB	S_REQ64#	S_CBE2#	S_AD09	S_CBE1#	S_PERR#	S_AD12	S_SERR#	S_STOP#	S_VCCA	VSS	S_CLKI	
AC	VSS	VSS	S_AD05	VCCP	S_AD08	VSS	S_IRDY#	MT1#	S_DEVSEL#	IDSEL_MASK	VSS	
	13	14	15	16	17	18	19	20	21	22	23	

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Signal Pin Types and Descriptions 2

Table 2 lists and describes the 31154 133MHz PCI Bridge signal pin types.

Table 2. Signal Pin Types

Symbol	Description
I	Input pin only
O	Output pin only
I/O	Pin can be either an input or output
OD	Open Drain pin
Ts	Tri-State
Sts	Sustained Tri-State
PWR	Power pin (See Section 2.9)
GND	Ground (See Section 2.9)

The following sections describe the signals for the PCI interfaces.

- [Section 2.1, “PCI Bus Interfaces”](#)
- [Section 2.2, “PCI Bus Interface 64-Bit Extension”](#)
- [Section 2.3, “Bus Interface Clocks and Reset”](#)
- [Section 2.4, “JTAG Interface”](#)
- [Section 2.5, “Serial EEROM Interface”](#)
- [Section 2.6, “Compact PCI Hot Swap Interface”](#)
- [Section 2.7, “Hardware Straps”](#)
- [Section 2.8, “Miscellaneous Signals”](#)
- [Section 2.9, “Power and Ground Signals”](#)
- [Section 2.10, “Ball Table Mappings”](#)

The “#” symbol at the end of a signal name indicates that the active or asserted state occurs when the signal is at a low voltage level. When “#” is not present after the signal name, the signal is asserted when at the high voltage level.

2.1 PCI Bus Interfaces

This section describes the signals related to the PCI Bus Interfaces. The 31154 133MHz PCI Bridge implements two independent PCI-X buses (a Primary and a Secondary bus). See the *PCI-X Addendum to the PCI Local Bus Specification 1.0b* for more information.

Table 3. PCI Bus Interfaces (Sheet 1 of 3)

Signal	Width	Type	Description
P_AD[31:0]; S_AD[31:0]	32; 32	Ts-I/O	PCI Address/Data: These signals are a multiplexed address and data bus. During the address phase or phases of a transaction, the initiator drives a physical address on AD[31:0]. During the data phases of a transaction, the initiator drives write data, or the target drives read data.
P_CBE#[3:0]; S_CBE#[3:0]	4; 4	Ts-I/O	Bus Command and Byte Enables: These signals are a multiplexed command field and byte-enable field. During the address phase or phases of a transaction, the initiator drives the transaction type on C/BE#[3:0]. When there are two address phases, the first address phase carries the dual address command and the second address phase carries transaction type. For both read and write transactions, the initiator drives byte enables on C/BE#[3:0] during the data phases.
P_PAR; S_PAR	1; 1	Ts-I/O	Parity: Even parity calculated on 36 bits – AD[31:0] plus C/BE#[3:0]#. This is calculated on all 36 bits regardless of the valid byte enables, and is generated for address and data phases. This is driven identically to the AD[31:0] lines, except that it is delayed by exactly one PCI clock. PAR is an output during the address phase for all 31154 133MHz PCI Bridge-initiated transactions and all data phases when 31154 133MHz PCI Bridge is the initiator of a PCI write transaction.
P_DEVSEL#; S_DEVSEL#	1; 1	Sts-I/ O	Device Select: As a target, the 31154 133MHz PCI Bridge asserts DEVSEL# when a PCI master peripheral attempts to access an internal address or the address of a resource that resides on the 31154 133MHz PCI Bridge's other bus. As an initiator, DEVSEL# indicates the response to a 31154 133MHz PCI Bridge-initiated transaction on the PCI bus. DEVSEL# is tri-stated from the leading edge of PCIRST#. DEVSEL# remains tri-stated by the 31154 133MHz PCI Bridge until driven as a target.
P_FRAME#; S_FRAME#	1; 1	Sts-I/ O	Frame: FRAME# is driven by the Initiator to indicate the beginning and duration of an access. While FRAME# is asserted, data transfers continue. When FRAME# is negated, the bus is either idle or is in the final data phase of the current bus transaction.
P_IRDY#; S_IRDY#	1; 1	Sts-I/ O	Initiator Ready: IRDY# indicates the ability of the initiator to complete the current data phase of the transaction. A data phase is completed when both IRDY# and TRDY# are sampled asserted.
P_TRDY#; S_TRDY#	1; 1	Sts-I/ O	Target Ready: Indicates the ability of the target to complete the current data phase of the transaction. A data phase is completed when both TRDY# and IRDY# are sampled asserted. TRDY# is tri-stated from the leading edge of PCIRST#. TRDY# remains tri-stated by the 31154 133MHz PCI Bridge until driven as a target.
P_STOP#; S_STOP#	1; 1	Sts-I/ O	Stop: Indicates that the target is requesting an initiator to stop the current transaction.

Table 3. PCI Bus Interfaces (Sheet 2 of 3)

Signal	Width	Type	Description
P_PERR#; S_PERR#	1; 1	Sts-I/ O	Parity Error: Driven by an external PCI device when it receives data that has a parity error one PCI Clock following the PAR/PAR64 signal assertion. Driven by the 31154 133MHz PCI Bridge when, as an initiator, it detects a parity error during a read transaction as well as when receiving bad parity as the target of a write transaction.
P_SERR#	1	Od	Primary System Error: SERR# can be pulsed active by any PCI device (including the 31154 133MHz PCI Bridge) that detects a system error.
S_SERR#	1	I	Secondary System Error: SERR# can be pulsed active by any PCI device (except the 31154 133MHz PCI Bridge) that detects a system error condition. The 31154 133MHz PCI Bridge samples SERR# as an input and conditionally forwards it to its primary interface.
P_REQ#	1	Ts-O	Primary Bus Request: The 31154 133MHz PCI Bridge bus acquisition request input to the primary bus arbiter.
P_GNT#	1	I	Primary Bus Grant: Low assertion indicates that the 31154 133MHz PCI Bridge is granted primary bus ownership following the completion of the current primary bus transaction.
S_REQ[8:1]#	8	I	Secondary PCI Requests: The internal arbiter supports up to nine external masters on the PCI bus using the S_REQ[8:1]# and S_REQ[0]# pins.
S_REQ[0]#/ BR_GNT#	1	I	Secondary PCI REQ[0]# or Bridge GNT#: Depending upon whether or not the internal secondary arbiter is enabled, this signal serves as either a PCI request or a PCI grant. <ul style="list-style-type: none"> When secondary arbiter is enabled this input represents S_REQ[0]#. When secondary arbiter is disabled, this input represents the 31154 133MHz PCI Bridge secondary bus master interface's PCI GNT#.
S_GNT[8:1]#	8	Ts-O	Secondary PCI Grants Supports up to nine other masters on the PCI bus. The arbiter can assert one of the nine bus grant outputs to indicate that an initiator can start a transaction on the PCI Bus following completion of the current transaction.
S_GNT[0]#/ BR_REQ#	1	TS-O	Secondary PCI GNT[0]# or Bridge REQ#: Depending upon whether or not the internal secondary arbiter is enabled, this signal serves as either a PCI request or a PCI grant. When secondary arbiter is enabled, this output represents S_GNT[0]#. When secondary arbiter is disabled, this output represents the 31154 133MHz PCI Bridge secondary bus master interface's PCI REQ#.

Table 3. PCI Bus Interfaces (Sheet 3 of 3)

Signal	Width	Type	Description
P_M66EN	1	I	<p>Primary 66MHz Enable: The Primary bus M66EN signal input is sampled on the trailing edge of P_RST#. This signal is used to determine the primary bus frequency when operating in conventional PCI mode.</p> <p>When sampled as 1b, Indicates that the primary bus interface will be operating in 66MHz mode.</p> <p>When sampled as 0b, Indicates that the 31154 133MHz PCI Bridge primary bus interface will be operating in 33MHz mode.</p> <p>When the primary bus emerges from P_RST# in PCI-X mode, the PCI-X initialization pattern broadcast by the Originating Device (host bridge typically) determines the primary bus frequency.</p>
P_IDSEL	1	I	<p>Primary ID SEL: This input serves as a high active chip select for Type 0 Configuration cycles that target the bridges configuration space registers.</p>
S_M66EN	1	I	<p>Secondary 66MHz Enable: S_M66EN, along with S_PCIXCAP, indicate the mode (conventional PCI vs. PCI-X), and maximum frequency capabilities of the secondary bus devices.</p>
S_PCIXCAP	1	I	<p>Secondary PCI-X Capable: S_PCIXCAP, along with S_M66EN, indicate the mode (conventional PCI vs. PCI-X), and maximum frequency capabilities of the secondary bus. Pin should be connected as shown in Table 4.</p>
Total	112		

Table 4. Device Mode/Frequency Capability Reporting

M66EN	PCIXCAP	Convention PCI Device Frequency Capability	PCI-X Device Frequency Capability
Ground	Ground	33 MHz	Not capable
Not connected	Ground	66 MHz	Not capable
Ground	Pull-down	33 MHz	PCI-X 66 MHz
Not connected	Pull-down	66 MHz	PCI-X 66 MHz
Ground	Not connected	33 MHz	PCI-X 133MHz
Not connected	Not connected	66 MHz	PCI-X 133MHz

2.2 PCI Bus Interface 64-Bit Extension

This section describes the signals related to 64 bit extension bus pins. Each PCI-X bus (Primary and Secondary) is capable of operating as a 32 or a 64 bit bus. Refer to PCI Local Bus Specification 3.0.

Table 5. PCI Bus Interface 64-Bit Extension (Two Interfaces)

Signal	Width	Type	Description
P_AD[63::32]	32	Ts-I/O	PCI Address/Data: Multiplexed upper address and data bus. This bus provides an additional 32 bits to the PCI bus. During the data phases of a transaction, the initiator drives the upper 32 bits of 64-bit write data, and during 64-bit read transactions the target drives the upper 32 bits of 64-bit read data. When not driven, AD[63:32] must be pulled up to a valid logic high level through external resistors.
S_AD[63::32]	32		
P_CBE#[7::4]	4	Ts-I/O	Bus Command and Byte enables upper 4 bits: These signals are a multiplexed command field and byte enable field. For both reads and write transactions, the initiator will drive byte enables for the AD[63:32] data bits on C/BE[7:4] during the data phases when REQ64# and ACK64# are both asserted. When not driven, C/BE#[7:4] is pulled up to a valid logic high level through external resistors.
S_CBE#[7::4]	4		
P_PAR64	1	Ts-I/O	PCI interface upper 32-bits parity: PAR64 carries the even parity of the 36 bits of AD[63:32] and C/BE#[7:4] for both address and data phases. When not driven, PAR64 is pulled up to a valid logic high level through an external resistor.
S_PAR64	1		
P_REQ64#	1	Sts-I/O	PCI interface request 64-bit transfer: REQ64# is asserted by the initiator to indicate that the initiator is requesting a 64-bit data transfer. It has the same timing as FRAME#. When the 31154 133MHz PCI Bridge is the initiator, this signal is an output. When the 31154 133MHz PCI Bridge is the target, this signal is an input.
S_REQ64#	1	XX	XX
P_ACK64#	1	Sts-I/O	PCI interface acknowledge 64-bit transfer: This is asserted by the target only when REQ64# is asserted by the initiator to indicate the target ability to transfer data using 64 bits. It has the same timing as DEVSEL#.
S_ACK64#	1		
Total	78		

2.3 Bus Interface Clocks and Reset

Table 6 describes the signals related to bus interface clocks and reset.

Table 6. Bus Interface Clocks and Reset

Signal	Width	Type	Description
P_CLK	1	I	Primary PCI Clock Input
S_BRGCLKO	1	O	Secondary Bridge Clock Output: This output is identical to the other S_CLKO but does not have individual disable control. This signal is recommend, since the feedback clock for the bridge should be connected to S_CLKI when the internal clock generation is used.
S_CLKO[8::0]	9	O	Secondary PCI Clock Outputs: 33/66/100/133 MHz clock for secondary bus PCI devices. These clocks can be disabled by strapping the S_CLKOEN[3:0] pins during reset.
S_CLKI	1	I	Secondary PCI Clock In: This signal is connected to an output of the low skew PCI clock buffer tree. When using the internal secondary clock generation, this pin should be connected to the S_BRGCLKO output.
S_CLKSTABLE	1	I	Secondary Clock Stable: This input is used to enforce the $T_{rst-clk}$ time as defined in the PCI Local Bus Specification. After this signal is asserted, the bridge will wait 100 μ S before de-asserting the secondary PCI reset. When using the internal secondary clock generation, this pin should be tied high.
S_GCLKOEN	1	I	Secondary Global Clock Output Enable: This pin should be pulled high to enable the secondary clock outputs. When de-asserted (0b), all secondary clock outputs (S_CLKO[8::0] and S_BRGCLKO) will asynchronously tri-state. If an external clock source is used on the secondary interface, this signal should be pulled-low.
S_CLKOEN[3:0]	4	I (strap)	Secondary Clock Enable These pins control the reset value of bits 8:0. The binary encoding on these pins indicates the number of secondary clock enabled.

Table 6. Bus Interface Clocks and Reset

Signal	Width	Type	Description
P_RST#	1	I	Primary PCI Reset
S_RST#	1	O	<p>Secondary PCI Reset: The 31154 133MHz PCI Bridge asserts S_RST# to reset devices that reside on its secondary PCI bus. The 31154 133MHz PCI Bridge asserts S_RST# due to one of the following events:</p> <ul style="list-style-type: none"> • P_RST# assertion • Setting the Secondary Bus Reset bit (bit 6) in the Bridge Control Register. <p>If PME# support from the D3_{cold} is required, then a weak pull-down should be placed on the S_RST# line. This, in conjunction with PME# which is routed around the bridge, enables ACPI S3 (or higher) PME# operation for downstream PCI-PM compliant PCI agents.</p>
Total	20		

2.4 JTAG Interface

Table 7 describes the signals related to the JTAG interface.

Table 7. JTAG (Sheet 1 of 2)

Signal	Width	Type	Description
TDI	1	I	<p>Test Data In: TDI is the serial input through which JTAG instructions and test data enter the JTAG interface. TDI is sampled on the rising edge of TCK. If TDI is not driven, it produces the same results as if TDI were driven high.</p>
TDO	1	O	<p>Test Data Out: TDO is the serial output through which test instructions and data from the test logic leave 31154 133MHz PCI Bridge.</p>
TMS	1	I	<p>Test Mode Select: TMS causes state transitions in the test access port (TAP) controller. If TMS is not driven, it produces the same results as if TMS were driven high.</p>
TCK	1	I	<p>Test Clock: TCK is the clock controlling the JTAG logic. For systems that do not implement JTAG, this input should be pulled low.</p>
TRST#	1	I	<p>Test Reset: When TRST# is asserted (driven low), the TAP controller is asynchronously forced to enter a reset state, which in turn asynchronously initializes other test logic. TRST# must be pulled low to GND for normal operation.</p>
SCAN_EN	1	I	<p>SCAN Mode Select: The SCAN_EN pin toggles between the shift operation and the capture operation in the scan testing mode. It is used for scan chain testing of the device only. During normal operation, this input should be tied low.</p>

Table 7. JTAG (Sheet 2 of 2)

Signal	Width	Type	Description
TMODE[3:0]	4	I	Test Mode Select: These four pins are used to internally test 31154 133MHz PCI Bridge at the time of manufacture. TMODE3 must be tied to V _{SS} (logic 0) for normal operation. TMODE[2:0] all three pins must be tied to V _{SS} (preferred) or all must be tied to V _{CC} . Normal Operation => 0000 or 0111.
MT#[1:0]	2	I	Manufacture Test pins. These two pins must be pulled high for normal operation.
Total	12		

2.5 Serial EEROM Interface

Table 8 describes the signals related to the Serial EEROM interface.

Table 8. Serial EEROM Interface

Signal	Width	Type	Description
SR_CLK	1	Ts-O	Serial EEROM Clock: Clock output. This pin is connected to the EEROM clock input
SR_DI	1	Ts-O	Serial EEROM Data In: Serial data stream output that is connected to the EEROM DI input.
SR_DO	1	I	Serial EEROM Data out: Serial data stream input that is connected to the EEROMs DO output
SR_CS	1	Ts-O	Serial EEROM chip select: The 31154 133MHz PCI Bridge drives this signal high to enable the serial ROM for a read or write cycle.
Total	4		

2.6 Compact PCI Hot Swap Interface

Table 9 describes the signals related to the cPCI PCS Hot Swap interface.

Table 9. Compact PCI Hot Swap

Signal	Width	Type	Description
HS_ENUM#	1	Od-O	Primary Bus Compact PCI Hot Swap Event: This is conditionally asserted to notify the system host that either a board has been freshly inserted or is about to be extracted. This signal informs the system host that the configuration of the system has changed. The system host then performs any necessary maintenance, such as installing or quiescing a device driver.
HS_LSTAT	1	I	Compact PCI Hot Swap Latch Status: This is an input to the bridge, indicating the state of the ejector switch. 0= Indicates the ejector switch is closed 1=Indicates the ejector switch is open If Compact PCI Hot Swap is not supported, this signal must be tied low.
HS_LED_OUT	1	O	LED Output: The 31154 133MHz PCI Bridge outputs a logic one to illuminate the Hot Swap LED.
HS_SM	1	I	Hot swap Startup Mode: This pin is sampled at the rising edge of P_RST#. If 0b, The 31154 133MHz PCI Bridge retries any Type 0 Configuration cycles addressed to it until its serial ROM preload has completed. If 1b, the 31154 133MHz PCI Bridge ignores (causes a master abort) any Type 0 configuration cycles addressed to it until its serial ROM preload has completed. This pin should be tied low for non-Hot Swap systems.
HS_FREQ[1:0]	2	I	This pins are reserved for determining Primary Bus frequency and mode during a PCI-X hot swap event and are valid only when HS_SM = 1. The bus frequency and mode are described below: 00 => PCI Mode, 33 or 66 MHz. Use P_M66EN to determine frequency 01 => PCI-X Mode, 66 MHz 10 => PCI-X Mode, 100 MHz 11 => PCI-X Mode, 133 MHz These pins should be tied low for non-Hot Swap systems.
Total	6		

2.7 Hardware Straps

Table 10 describes the signals related to the hardware straps. These are sampled during and on the trailing edge of P_RST# to set the mode of operation of the device.

Table 10. Hardware Straps

Signal	Width	Type	Description
S_ARB_DISABLE/ S_ARB_LOCK	1	I	<p>Secondary Arbiter Disable / Arbiter Lock:</p> <p>If sampled as 1b at the trailing edge of P_RST#, the internal secondary bus arbiter is disabled. In this event S_GNT#[0] is used for the bridge's secondary bus request output, and S_REQ#[0] is used for the bridge's secondary bus grant input.</p> <p>If a logic low is sampled at the trailing edge of P_RST#, the bridge's internal secondary arbiter is enabled for use. This pin must have either a pull-up resistor to V_{DD}, or a pull down resistor to V_{SS}. It must not be left floating.</p> <p>If sampled as 1b after the trailing edge of P_RST#, the bridge's internal secondary bus arbiter will lock and only provide the grant to itself.</p>
S_MAX100	1	I (strap)	<p>Secondary Bus Maximum Frequency:</p> <p>This trap bits, sampled on the trailing edge of P_RST#, provides the 31154 133MHz PCI Bridge with necessary system specific secondary bus loading information that is required to correctly establish the maximum secondary bus clock frequency when operating in PCI-X mode.</p> <p>When asserted the secondary bus frequency will be limited to a maximum of 100MHz.</p> <p>This pin must have either pull-up resistors to V_{DD}, or pull down resistors to V_{SS}. It must not be left floating.</p>
OPAQUE_EN	1	I (strap)	<p>Opaque Memory Space Enable:</p> <p>If sampled high at the trailing edge of P_RST#, the 31154 133MHz PCI Bridge will set bit 11 in the "offset 46H:VCR2 – the 31154 133MHz PCI Bridge Control Register 2". This will enable the Opaque Memory Base/Limit registers. This establishes a private memory space for secondary bus usage, independent of the 31154 133MHz PCI Bridge downstream forwarding configuration.</p>
IDSEL_MASK	1	I (strap)	<p>IDSEL Masking Enable.</p> <p>If sampled high at the trailing edge of P_RST#, the 31154 133MHz PCI Bridge will change the default value of the "Offset 5CH: Secondary IDSEL Select Register – SISR". This will hide devices 16-21 from the host.</p>
DEV_64BIT#	1	I (strap)	<p>This signal is sampled on the trailing edge of P_RST# and sets bit 16 in the PCI-X Bridge Status Register. This strap is to support system management software and does not change the behavior to the bridge.</p>
Total	5		

2.8 Miscellaneous Signals

Table 11 describes the signals related to the special features of the 31154 133MHz PCI Bridge.

Table 11. Miscellaneous Signals (Sheet 1 of 2)

Signal	Width	Type	Description
QE	1	O	<p>Queues Empty:</p> <p>This output indicates the state of the 31154 133MHz PCI Bridge internal request and data queues. When at a logic high level, this signal indicate that the 31154 133MHz PCI Bridge internal queues are completely empty.</p> <p>This state of this output is valid only when the NT_MASK# pin is asserted.</p>
NT_MASK#	1	I	<p>New Transaction Mask:</p> <p>When this pin is sampled asserted (logic low level), the 31154 133MHz PCI Bridge does not enqueue any new transactions, except PCI configuration cycles targeting its configuration registers. Transactions enqueued at the time that this signal is sampled asserted are allowed to complete normally. Applications could, for example, use this pin and the QE pin to implement external hardware that flushes the 31154 133MHz PCI Bridge request and data queues.</p>
S_TRISTATE	1	I	<p>Secondary Bus Tri-State Enable:</p> <p>All Secondary bus outputs (except S_BRGCKO) are asynchronously tri-stated when this signal is asserted(1b).</p> <p>In cPCI systems this input can be used to support Redundant System Slot (RSS) implementations.</p> <p>In non-RSS platforms, this pin should be tied directly to ground.</p>
GPIO[7:0]	8	I/O	General Purpose I/O.
P_VIO	1	I	<p>Primary Bus PCI Universal I/O Voltage Reference:</p> <p>This signal must be tied to either 3.3V or 5V, corresponding to the signaling environment of the primary PCI bus as described in the PCI Local Bus Specification. When any device on the primary bus uses 5V signaling levels, the system must connect P_VIO to 5V. P_VIO is connected to 3.3V by the system only when all the devices on the primary bus use 3.3V signaling levels.</p>
S_VIO	1	I	<p>Secondary Bus PCI Universal I/O Voltage Reference:</p> <p>This signal must be tied to either 3.3V or 5V, corresponding to the signaling environment of the secondary PCI bus as described in the PCI Local Bus Specification. When any device on the secondary bus uses 5V signaling levels, the system must connect S_VIO to 5V. S_VIO is connected to 3.3V by the system only when all the devices on the secondary bus use 3.3V signaling levels.</p>
R_REF	1	I	<p>R_REF:</p> <p>This pin is connected to an external (board-level) precision pull-down resistor. The resistor is used as a reference for setting the I/O buffers output drive AC and DC parametrics, enabling the output buffers to meet the PCI/PCI-X parametric specifications. R=30Ω</p>
NC	1	O	<p>No Connect:</p> <p>This output should be left floating.</p>

Table 11. Miscellaneous Signals (Sheet 2 of 2)

Signal	Width	Type	Description
RSRV[1:0]	2	I	Reserved: The reserved inputs should be pulled to a valid logic level.
Total	17		

2.9 Power and Ground Signals

Table 12 describes the power and ground-related signals.

Table 12. Power and Ground Signals

Signal	Type	Description
S_VCCA	PWR	Secondary bus clock PLL Supply Voltage
P_VCCA	PWR	Primary bus clock PLL Supply Voltage
VCC	PWR	1.3V Supply Voltage
VCCP	PWR	3.3V Supply Voltage
P_VIO	PWR	Primary Reference Supply Voltage
S_VIO	PWR	Secondary Reference Supply Voltage
VSS	GND	Ground

2.10 Ball Table Mappings

The pinout for the 31154 133MHz PCI Bridge PCI-X to PCI-X Bridge is described in the following tables. Table 13 lists the pinout entries in ballpad number order. Table 14 lists the entries alphabetically in signal order.

Table 13. Pinout – Ballpad Number Order (Sheet 1 of 7)

Ball Number	Signal	Ball Number	Signal
A1	VSS	A13	P_CBE0#
A2	P_ACK64#	A14	VSS
A3	P_AD56	A15	P_CBE3#
A4	P_AD60	A16	P_IRDY#
A5	P_CBE4#	A17	P_FRAME#
A6	VSS	A18	VSS
A7	P_CBE7#	A19	P_AD04
A8	VCCP	A20	P_AD07
A9	P_PAR64	A21	P_VCCA
A10	VSS	A22	VCCP
A11	VSS	A23	VSS
A12	VCCP	B1	P_AD43

Table 13. Pinout – Ballpad Number Order (Sheet 2 of 7)

Ball Number	Signal	Ball Number	Signal
B2	VSS	C17	P_AD09
B3	P_AD54	C18	P_PAR
B4	P_SERR#	C19	P_AD10
B5	P_AD49	C20	P_GNT#
B6	P_AD50	C21	VSS
B7	P_AD52	C22	TDI
B8	P_AD55	C23	TRST#
B9	P_AD57	D1	S_CLKOEN2
B10	P_AD59	D2	P_AD47
B11	P_AD63	D3	QE
B12	P_CBE6#	D4	VSS
B13	P_AD00	D5	VCCP
B14	P_AD02	D6	P_AD51
B15	P_TRDY#	D7	VCCP
B16	P_AD05	D8	VSS
B17	P_AD08	D9	VCC
B18	P_CBE1#	D10	P_AD62
B19	P_IDSEL	D11	VCC
B20	P_AD15	D12	VSS
B21	P_REQ#	D13	VCC
B22	VSS	D14	P_CBE2#
B23	TDO	D15	VCC
C1	SCAN_EN	D16	VSS
C2	P_AD48	D17	VCCP
C3	VSS	D18	P_AD11
C4	P_STOP#	D19	VCCP
C5	VCCP	D20	VSS
C6	S_CLKOEN3	D21	P_DEVSEL#
C7	P_AD53	D22	TMS
C8	P_PERR#	D23	P_AD22
C9	P_AD58	E1	P_AD38
C10	P_AD61	E2	S_CLKOEN1
C11	P_CBE5#	E3	P_AD45
C12	P_REQ64#	E4	VCCP
C13	P_AD01	E5	R_REF
C14	MT0#	E6	VSS
C15	P_AD03	E7	HS_LED_OUT
C16	P_AD06	E8	HS_LSTAT

Table 13. Pinout – Ballpad Number Order (Sheet 3 of 7)

Ball Number	Signal	Ball Number	Signal
E9	HS_ENUM#	F15	VCC
E10	VSS	F16	VSS
E11	S_TRISTATE	F17	VCC
E12	HS_FREQ0	F18	VSS
E13	HS_FREQ1	F19	VSS
E14	VSS	F20	P_AD13
E15	NT_MASK#	F21	TCK
E16	GPIO0	F22	P_AD12
E17	GPIO1	F23	VSS
E18	VSS	F1	VSS
E19	GPIO2	F10	VCC
E20	VCCP	F14	VSS
E21	P_CLK	G1	P_AD36
E22	P_RST#	G2	S_CLKOEN0
E23	P_AD24	G3	P_AD41
F1	VSS	G4	VCCP
F2	P_AD42	G5	HS_SM
F3	P_AD44	G6	VSS
F4	P_AD46	G18	VCC
F5	VSS	G19	VSS
F6	VCC	G20	VCCP
F7	VSS	G21	P_AD16
F8	VCC	G22	P_AD14
F9	VSS	G23	P_AD26
F10	VCC	H1	P_AD35
F14	VSS	H3	P_AD40
F15	VCC	H4	VSS
F16	VSS	H5	P_M66EN
F17	VCC	H6	VCC
F18	VSS	H18	VSS
F19	VSS	H19	VCC
F20	P_AD13	H2	P_AD39
F21	TCK	H20	VSS
F22	P_AD12	H21	P_AD18
F23	VSS	H22	P_AD17
F1	VSS	H23	P_VIO
F10	VCC	J1	P_AD33
F14	VSS	J2	P_AD34

Table 13. Pinout – Ballpad Number Order (Sheet 4 of 7)

Ball Number	Signal	Ball Number	Signal
J3	P_AD37	L20	VCC
J4	VCC	L21	P_AD28
J5	SR_CLK	L22	P_AD27
J6	VSS	L23	VSS
J18	S_CLKO0	M1	VCCP
J19	S_CLKO2	M2	S_AD39
J20	VCC	M3	S_AD38
J21	P_AD20	M4	VSS
J22	P_AD19	M5	SR_DO
J23	P_AD31	M10	VSS
K1	VSS	M11	VSS
K2	S_AD34	M12	VSS
K3	S_AD33	M13	VSS
K4	S_AD32	M14	VSS
K5	VSS	M19	S_CLKO5
K6	VCC	M20	VSS
K10	VSS	M21	P_AD30
K11	VSS	M22	P_AD29
K12	VSS	M23	S_AD27
K13	VSS	N1	VSS
K14	VSS	N2	S_AD41
K18	S_CLKO1	N3	S_AD40
K19	S_CLKO4	N4	VCC
K20	P_AD25	N5	SR_DI
K21	P_AD23	N10	VSS
K22	P_AD21	N11	VSS
K23	VSS	N12	VSS
L1	P_AD32	N13	VSS
L2	S_AD36	N14	VSS
L3	S_AD35	N19	S_CLKO6
L4	VCC	N20	VCC
L5	SR_CS	N21	S_AD30
L10	VSS	N22	S_AD31
L11	VSS	N23	S_AD25
L12	VSS	P1	VSS
L13	VSS	P2	S_AD47
L14	VSS	P3	S_AD45
L19	S_CLKO3	P4	S_AD43

Table 13. Pinout – Ballpad Number Order (Sheet 5 of 7)

Ball Number	Signal	Ball Number	Signal
P5	VSS	U2	S_AD53
P6	VSS	U3	S_AD52
P10	VSS	U4	VCCP
P11	VSS	U5	S_GNT6#
P12	VSS	U6	VCC
P13	VSS	U18	VSS
P14	VSS	U19	S_GCLKOEN
P18	S_BRGCKO	U20	VCCP
P19	S_CLKO7	U21	S_AD18
P20	S_AD26	U22	S_AD19
P21	S_AD28	U23	S_RST#
P22	S_AD29	V1	VSS
P23	VSS	V2	S_AD55
R1	S_AD37	V3	S_MAX100
R2	S_AD49	V4	S_AD54
R3	S_AD48	V5	VSS
R4	VCC	V6	VSS
R5	S_GNT7#	V7	VCC
R6	VCC	V8	VSS
R18	S_M66EN	V9	VCC
R19	S_CLKO8	V10	VSS
R20	VCC	V14	VCC
R21	S_AD22	V15	GPIO3
R22	S_AD24	V16	GPIO5
R23	S_PCIXCAP	V17	S_GNT8#
T1	S_VIO	V18	VCC
T2	S_AD51	V19	VSS
T3	S_AD50	V20	S_AD14
T4	VSS	V21	S_AD16
T5	S_REQ7#	V22	S_AD17
T6	VSS	V23	VSS
T18	VCC	W1	S_AD44
T19	VCC	W2	S_REQ2#
T20	VSS	W3	S_CLKSTABLE
T21	S_ARB_DISABLE	W4	VCCP
T22	S_AD20	W5	S_REQ6#
T23	S_AD23	W6	VSS
U1	S_AD42	W7	VSS

Table 13. Pinout – Ballpad Number Order (Sheet 6 of 7)

Ball Number	Signal	Ball Number	Signal
W8	VSS	Y23	TMODE3
W9	VSS	AA1	NC
W10	VSS	AA2	S_REQ1#
W11	VSS	AA3	VSS
W12	VSS	AA4	TMODE2
W13	VCC	AA5	S_AD58
W14	VSS	AA6	S_AD59
W15	S_REQ8#	AA7	S_AD61
W16	GPIO4	AA8	S_ACK64#
W17	GPIO6	AA9	S_AD00
W18	GPIO7	AA10	S_PAR64
W19	VSS	AA11	S_CBE5#
W20	VCCP	AA12	S_AD06
W21	S_AD15	AA13	S_AD07
W22	TMODE0	AA14	S_FRAME#
W23	S_AD21	AA15	S_CBE3#
Y1	S_AD46	AA16	S_AD10
Y2	S_GNT2#	AA17	S_PAR
Y3	S_AD56	AA18	OPAQUE_EN
Y4	VSS	AA19	S_GNT0#
Y5	VCCP	AA20	S_AD13
Y6	S_AD57	AA21	VSS
Y7	VCCP	AA22	RSRV0
Y8	VSS	AA23	S_REQ0#
Y9	VCC	AB1	S_GNT1#
Y10	S_CBE7#	AB2	VSS
Y11	VCC	AB3	S_REQ3#
Y12	VSS	AB4	S_GNT4#
Y13	VCC	AB5	S_REQ4#
Y14	S_TRDY#	AB6	S_AD60
Y15	VCC	AB7	S_AD62
Y16	VSS	AB8	S_AD63
Y17	VCCP	AB9	S_AD01
Y18	S_AD11	AB10	S_CBE6#
Y19	VCCP	AB11	S_AD04
Y20	VSS	AB12	S_CBE0#
Y21	TMODE1	AB13	S_REQ64#
Y22	DEV_64BIT#	AB14	S_CBE2#

Table 13. Pinout – Ballpad Number Order (Sheet 7 of 7)

Ball Number	Signal	Ball Number	Signal
AB15	S_AD09	AC8	S_CBE4#
AB16	S_CBE1#	AC9	S_AD02
AB17	S_PERR#	AC10	VSS
AB18	S_AD12	AC11	S_AD03
AB19	S_SERR#	AC12	VCCP
AB20	S_STOP#	AC13	VSS
AB21	S_VCCA	AC14	VSS
AB22	VSS	AC15	S_AD05
AB23	S_CLKI	AC16	VCCP
AC1	VSS	AC17	S_AD08
AC2	VCCP	AC18	VSS
AC3	S_REQ5#	AC19	S_IRDY#
AC4	S_GNT5#	AC20	MT1#
AC5	S_GNT3#	AC21	S_DEVSEL#
AC6	VSS	AC22	IDSEL_MASK
AC7	RSRV1	AC23	VSS

See [Table 14 on page 30](#) for a list of pinout entries in signal order.

Table 14 lists the 31154 133MHz PCI Bridge pinout entries alphabetically in signal order.

Table 14. Pinout – Signal Order (Sheet 1 of 6)

Signal	Ball Number	Signal	Ball Number
DEV_64BIT#	Y22	P_AD16	G21
GPIO0	E16	P_AD17	H22
GPIO1	E17	P_AD18	H21
GPIO2	E19	P_AD19	J22
GPIO3	V15	P_AD20	J21
GPIO4	W16	P_AD21	K22
GPIO5	V16	P_AD22	D23
GPIO6	W17	P_AD23	K21
GPIO7	W18	P_AD24	E23
HS_ENUM#	E9	P_AD25	K20
HS_FREQ0	E12	P_AD26	G23
HS_FREQ1	E13	P_AD27	L22
HS_LED_OUT	E7	P_AD28	L21
HS_LSTAT	E8	P_AD29	M22
HS_SM	G5	P_AD30	M21
IDSEL_MASK	AC22	P_AD31	J23
NC	AA1	P_AD32	L1
NT_MASK#	E15	P_AD33	J1
OPAQUE_EN	AA18	P_AD34	J2
P_ACK64#	A2	P_AD35	H1
P_AD00	B13	P_AD36	G1
P_AD01	C13	P_AD37	J3
P_AD02	B14	P_AD38	E1
P_AD03	C15	P_AD39	H2
P_AD04	A19	P_AD40	H3
P_AD05	B16	P_AD41	G3
P_AD06	C16	P_AD42	F2
P_AD07	A20	P_AD43	B1
P_AD08	B17	P_AD44	F3
P_AD09	C17	P_AD45	E3
P_AD10	C19	P_AD46	F4
P_AD11	D18	P_AD47	D2
P_AD12	F22	P_AD48	C2
P_AD13	F20	P_AD49	B5
P_AD14	G22	P_AD50	B6
P_AD15	B20	P_AD51	D6

Table 14. Pinout – Signal Order (Sheet 2 of 6)

Signal	Ball Number	Signal	Ball Number
P_AD52	B7	P_VIO	H23
P_AD53	C7	QE	D3
P_AD54	B3	R_REF	E5
P_AD55	B8	RSRV0	AA22
P_AD56	A3	RSRV1	AC7
P_AD57	B9	S_ACK64#	AA8
P_AD58	C9	S_AD00	AA9
P_AD59	B10	S_AD01	AB9
P_AD60	A4	S_AD02	AC9
P_AD61	C10	S_AD03	AC11
P_AD62	D10	S_AD04	AB11
P_AD63	B11	S_AD05	AC15
P_CBE0#	A13	S_AD06	AA12
P_CBE1#	B18	S_AD07	AA13
P_CBE2#	D14	S_AD08	AC17
P_CBE3#	A15	S_AD09	AB15
P_CBE4#	A5	S_AD10	AA16
P_CBE5#	C11	S_AD11	Y18
P_CBE6#	B12	S_AD12	AB18
P_CBE7#	A7	S_AD13	AA20
P_CLK	E21	S_AD14	V20
P_DEVSEL#	D21	S_AD15	W21
P_FRAME#	A17	S_AD16	V21
P_GNT#	C20	S_AD17	V22
P_IDSEL	B19	S_AD18	U21
P_IRDY#	A16	S_AD19	U22
MT0#	C14	S_AD20	T22
P_M66EN	H5	S_AD21	W23
P_PAR	C18	S_AD22	R21
P_PAR64	A9	S_AD23	T23
P_PERR#	C8	S_AD24	R22
P_REQ#	B21	S_AD25	N23
P_REQ64#	C12	S_AD26	P20
P_RST#	E22	S_AD27	M23
P_SERR#	B4	S_AD28	P21
P_STOP#	C4	S_AD29	P22
P_TRDY#	B15	S_AD30	N21
P_VCCA	A21	S_AD31	N22

Table 14. Pinout – Signal Order (Sheet 3 of 6)

Signal	Ball Number	Signal	Ball Number
S_AD32	K4	S_CBE4#	AC8
S_AD33	K3	S_CBE5#	AA11
S_AD34	K2	S_CBE6#	AB10
S_AD35	L3	S_CBE7#	Y10
S_AD36	L2	S_CLKI	AB23
S_AD37	R1	S_CLKO0	J18
S_AD38	M3	S_CLKO1	K18
S_AD39	M2	S_CLKO2	J19
S_AD40	N3	S_CLKO3	L19
S_AD41	N2	S_CLKO4	K19
S_AD42	U1	S_CLKO5	M19
S_AD43	P4	S_CLKO6	N19
S_AD44	W1	S_CLKO7	P19
S_AD45	P3	S_CLKO8	R19
S_AD46	Y1	S_CLKOEN0	G2
S_AD47	P2	S_CLKOEN1	E2
S_AD48	R3	S_CLKOEN2	D1
S_AD49	R2	S_CLKOEN3	C6
S_AD50	T3	S_CLKSTABLE	W3
S_AD51	T2	S_DEVSEL#	AC21
S_AD52	U3	S_FRAME#	AA14
S_AD53	U2	S_GCLKOEN	U19
S_AD54	V4	S_GNT0#	AA19
S_AD55	V2	S_GNT1#	AB1
S_AD56	Y3	S_GNT2#	Y2
S_AD57	Y6	S_GNT3#	AC5
S_AD58	AA5	S_GNT4#	AB4
S_AD59	AA6	S_GNT5#	AC4
S_AD60	AB6	S_GNT6#	U5
S_AD61	AA7	S_GNT7#	R5
S_AD62	AB7	S_GNT8#	V17
S_AD63	AB8	S_IRDY#	AC19
S_ARB_DISABLE	T21	MT1#	AC20
S_BRGCLKO	P18	S_M66EN	R18
S_CBE0#	AB12	S_MAX100	V3
S_CBE1#	AB16	S_PAR	AA17
S_CBE2#	AB14	S_PAR64	AA10
S_CBE3#	AA15	S_PCIXCAP	R23

Table 14. Pinout – Signal Order (Sheet 4 of 6)

Signal	Ball Number	Signal	Ball Number
S_PERR#	AB17	VCC	F10
S_REQ0#	AA23	VCC	F15
S_REQ1#	AA2	VCC	F17
S_REQ2#	W2	VCC	G18
S_REQ3#	AB3	VCC	H6
S_REQ4#	AB5	VCC	H19
S_REQ5#	AC3	VCC	J4
S_REQ6#	W5	VCC	J20
S_REQ64#	AB13	VCC	K6
S_REQ7#	T5	VCC	L4
S_REQ8#	W15	VCC	L20
S_RST#	U23	VCC	N4
S_SERR#	AB19	VCC	N20
S_STOP#	AB20	VCC	R4
S_TRDY#	Y14	VCC	R20
S_TRISTATE	E11	VCC	R6
S_VCCA	AB21	VCC	T18
S_VIO	T1	VCC	T19
SCAN_EN	C1	VCC	U6
SR_CLK	J5	VCC	V7
SR_CS	L5	VCC	V9
SR_DI	N5	VCC	V14
SR_DO	M5	VCC	V18
TCK	F21	VCC	W13
TDI	C22	VCC	Y9
TDO	B23	VCC	Y11
TMODE0	W22	VCC	Y13
TMODE1	Y21	VCC	Y15
TMODE2	AA4	VCCP	A8
TMODE3	Y23	VCCP	A12
TMS	D22	VCCP	A22
TRST#	C23	VCCP	AC2
VCC	D9	VCCP	AC12
VCC	D11	VCCP	AC16
VCC	D13	VCCP	C5
VCC	D15	VCCP	D5
VCC	F6	VCCP	D7
VCC	F8	VCCP	D17

Table 14. Pinout – Signal Order (Sheet 5 of 6)

Signal	Ball Number	Signal	Ball Number
VCCP	D19	VSS	F14
VCCP	E4	VSS	F16
VCCP	E20	VSS	F18
VCCP	G4	VSS	F19
VCCP	G20	VSS	F23
VCCP	M1	VSS	G6
VCCP	U4	VSS	G19
VCCP	U20	VSS	H4
VCCP	W4	VSS	H18
VCCP	W20	VSS	H20
VCCP	Y5	VSS	J6
VCCP	Y7	VSS	K1
VCCP	Y17	VSS	K5
VCCP	Y19	VSS	K10
VSS	A1	VSS	K11
VSS	A6	VSS	K12
VSS	A10	VSS	K13
VSS	A11	VSS	K14
VSS	A14	VSS	K23
VSS	A18	VSS	L10
VSS	A23	VSS	L11
VSS	B2	VSS	L12
VSS	B22	VSS	L13
VSS	C3	VSS	L14
VSS	C21	VSS	L23
VSS	D4	VSS	M4
VSS	D8	VSS	M10
VSS	D12	VSS	M11
VSS	D16	VSS	M12
VSS	D20	VSS	M13
VSS	E6	VSS	M14
VSS	E10	VSS	M20
VSS	E14	VSS	N1
VSS	E18	VSS	N10
VSS	F1	VSS	N11
VSS	F5	VSS	N12
VSS	F7	VSS	N13
VSS	F9	VSS	N14

Table 14. Pinout – Signal Order (Sheet 6 of 6)

Signal	Ball Number	Signal	Ball Number
VSS	P1	VSS	W9
VSS	P5	VSS	W10
VSS	P6	VSS	W11
VSS	P10	VSS	W12
VSS	P11	VSS	W14
VSS	P12	VSS	W19
VSS	P13	VSS	Y4
VSS	P14	VSS	Y8
VSS	P23	VSS	Y12
VSS	T20	VSS	Y16
VSS	T4	VSS	Y20
VSS	T6	VSS	AA3
VSS	U18	VSS	AA21
VSS	V1	VSS	AB2
VSS	V5	VSS	AB22
VSS	V6	VSS	AC1
VSS	V8	VSS	AC6
VSS	V10	VSS	AC10
VSS	V19	VSS	AC13
VSS	V23	VSS	AC14
VSS	W6	VSS	AC18
VSS	W7	VSS	AC23
VSS	W8		

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Electrical Specifications

3

This chapter describes the electrical specifications for the 31154 133MHz PCI Bridge.

3.1 Absolute Maximum Ratings

This section provides the Absolute Maximum ratings for the 31154 133MHz PCI Bridge. Do not exceed the parameters listed in [Table 15](#). Operations at the Absolute Maximum ratings are not guaranteed.

Caution: Stressing the device beyond the “Absolute Maximum Ratings” may cause permanent damage.

Table 15. Absolute Maximum Ratings

Parameter	Maximum Rating
Storage Temperature	-55°C to +125°C
Case Temperature Under Bias	0°C to +70°C
Supply Voltage VCCP wrt. VSS	0.5V to +4.1V
Supply Voltage S_VIO;P_VIO	0.5 to 5.5V
Supply Voltage VCC wrt. VSS	0.5V to +2.3V (Note 1)
Voltage on Any pin (non 5V tolerant) wrt. VSS	0.5V to V _{CCP} + 0.5V
Voltage on Any pin (5V tolerant) wrt. VSS	0.5V to 5.5V
NOTE: 1 - 2.3V for fuse programming only . Normally 2.1V.	

3.2 Operating Conditions

[Table 16](#) shows minimum and maximum voltage, frequency, and temperature specifications for the 31154 133MHz PCI Bridge.

Caution: Operation beyond the specified Operating Conditions is not recommended and extended exposure beyond the Operating Conditions may affect device reliability.

Table 16. Operating Conditions

Symbol	Parameter	Min	Max	Units	Notes
VCCP	3.3V Supply Voltage	3.0	3.6	V	
P_VIO; S_VIO	Reference Supply Voltage	3.0	5.25	V	See Section 3.4
VCC	1.3V Supply Voltage	1.235	1.365	V	Note 2

Table 16. Operating Conditions

Symbol	Parameter	Min	Max	Units	Notes
S_VCCA	PLL Supply Voltage	1.235	1.365	V	
P_VCCA	PLL Supply Voltage	1.235	1.365	V	
F _{P_CLK}	Input Clock Frequency	0	133	MHz	Note 1
F _{s_CLK}	Input Clock Frequency	0	133	MHz	Note 1
T _C	Case Temperature Under Bias	0	70	°C	
NOTES: 1- Any input clock frequency less then 25MHz use PLL in bypass mode, PLL output not guaranteed. 2- VCC is increased to 2.3V during fuse programming					

3.3 Power Supply and Thermal Requirements

Table 17 shows the power supply and thermal requirements for the 31154 133MHz PCI Bridge.

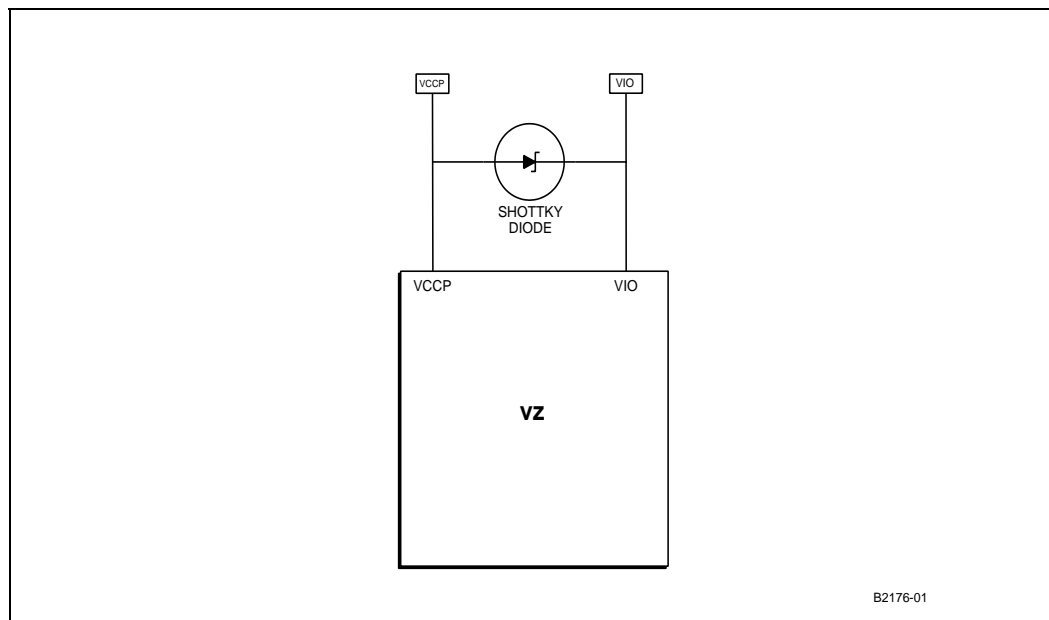
Table 17. Power Supply and Thermal Requirements

Voltage	Typical	Maximum	Units	Notes
3.3 V		2.5	Watts	Note 1
1.3 V		0.70	Watts	Note 1
Operational (Thermal Power)	1.75		Watts	Notes 2,3
NOTES: 1- For Sizing 3.3V and 1.3V Supplies (instantaneous maximums) 2 - 3.3V and 1.3V in operational modes. For thermal calculations (sustained maximums). 3 - $T_j = (80^{\circ}\text{C}) + (1.75\text{W}) * (18.5^{\circ}\text{C/W}) = 112^{\circ}\text{C}$				

3.4 Power Supply Special Considerations

If either P_VIO or S_VIO is not connected to the same power supply as Vccp, the user must perform one of the following steps:

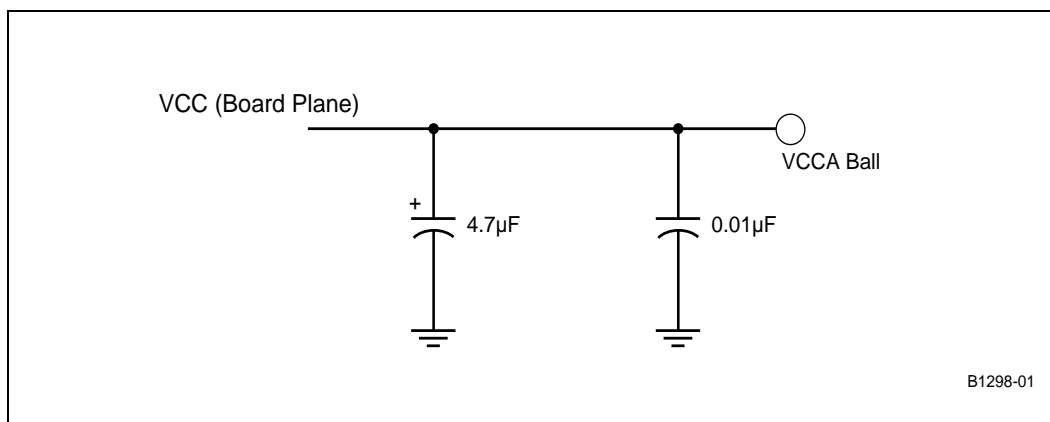
- Ensure that the P_VIO or S_VIO power comes up before or simultaneously with Vccp and ensure that the P_VIO or S_VIO power goes down after or simultaneously with Vccp.
- Install a Shottky diode, as shown in [Figure 4](#), between VCCP and the VIO pin/pins (as appropriate). The diode should be sized appropriately for the system's power environment. **(Recommended)**
- Connect a 250ohm current limit resistor in series with the P_VIO and S_VIO supply. P_VIO and S_VIO can never be at a lower voltage than VCCP except in the case of a 250ohm current limiting resistor in series with the P_VIO and S_VIO supply.

Figure 4. Installing a Shottky Diode

3.5 S_VCCA and P_VCCA Pin Requirements

To reduce clock skew and jitter, the P_VCCA and S_VCCA balls for the Phase Lock Loop (PLL) circuit are isolated on the package. The lowpass filter, as shown in [Figure 5](#), reduces noise induced clock jitter and its effects on timing relationships in system designs. The 4.7 μF capacitor must be (low ESR solid tantalum), the 0.01 μF capacitor must be of the type X7R and the node connecting VCCPLL must be as short as possible. The V_{SS} pins should be connected to the board ground plane immediately below capacitor.

Figure 5. S_VCCA and P_VCCA Lowpass Filter



3.6 Targeted DC Specifications

3.7 IO Types

Table 18 lists the 31154 133MHz PCI Bridge IO Types. These types are referred to in the subsections below.

Table 18. IO Types

Name	Type
PCI	PCI only
PCIX	PCIX Only
PCI-X	Both PCI and PCIX
cmos	Non PCI-X compliant IO

3.7.1 DC Characteristics

The DC characteristics for each pin include input sense levels and output drive levels and currents. These parameters can be used to determine maximum DC loading, and also to determine maximum transition times for a given load. The DC Operating Conditions for the High- and Low-Strength Input, Output, and I/O pins are shown in Table 19.

Table 19. DC Characteristics (Sheet 1 of 2)

Symbol	Parameter	Min	Max	Units	Notes
V _{IL1}	Input Low Voltage (cmos)	-0.3	0.8	V	Note 2
V _{IH1}	Input High Voltage (cmos)	2.0	V _{CCP} + 0.3	V	
V _{IL2}	Input Low Voltage (PCI-X)	-0.5	0.35V _{CCP}	V	
V _{IH2}	Input High Voltage (PCI-X/ PCI)	0.5V _{CCP}	V _{CCP} + 0.5	V	Note 1

Table 19. DC Characteristics (Sheet 2 of 2)

Symbol	Parameter	Min	Max	Units	Notes
V_{IL3}	Input Low Voltage (PCI)	-0.5	0.3VCCP	V	
V_{OL1}	Output Low Voltage (Misc)		0.4	V	$I_{OL} = 4 \text{ mA}$
V_{OH1}	Output High Voltage (Misc)	2.4		V	$I_{OH} = -2 \text{ mA}$
V_{OL3}	Output Low Voltage (PCI-X)		0.1VCCP	V	$I_{OL} = 1500\mu\text{A}$ (Note 1)
V_{OH3}	Output HIGH Voltage (PCI-X)	0.9VCCP		V	$I_{OH} = -500\mu\text{A}$ (Note 1)
C_{IN}	Input pin Capacitance		8	pF	
C_{CLK}	Clock pin Capacitance	5	8	pF	
L_{PIN}	Pin Inductance		15	nH	
NOTES: 1 - Pads are 5V Tolerant (not operational). 2 - CMOS IOs include all IOs that are not PCI or PCIX-compliant IOs.					

3.7.2 I_{CC} Characteristics

Table 20 describes the I_{CC} characteristics.

Table 20. I_{CC} Characteristics (Sheet 1 of 2)

Symbol	Parameter	Min	Max	Units	Notes
I_{LI1}	Input Leakage Current for each signal except TCK, TMS, TRST#, TDI	140	1000	μA	
I_{LI2}	Input Leakage Current for TCK, TMS, TRST#, TDI	140	1000	μA	
I_{CC33} Active (Power Supply)	Power Supply Current		0.70	A	
I_{CC13} Active (Power Supply)	Power Supply Current		0.65	A	
I_{CC13} Fuse Program (Power Supply)	Power Supply Current	.1	.1	A	

Table 20. Icc Characteristics (Sheet 2 of 2)

Symbol	Parameter	Min	Max	Units	Notes
I_{CC33} Active (Power Modes)	Reset Mode Hi-Z Mode	0.1	0.2	A	
I_{CC13} Active (Power Modes)	Reset Mode Hi-Z Mode	0.5	0.70	A	
I_{CC} Active (Power Supply) value is provided for selecting your system's power supply. This is measured using one of the worst case instruction mixes with VCCP = 3.6V, VCC = 1.365V, and ambient temperature = 55 °C. Input leakage currents include hi-Z output leakage for all bi-directional buffers with tri-state outputs.					

3.8 Targeted AC Specifications

The AC characteristics for each pin are described in the following sections.

3.8.1 Input Clock Timings

This section describes PCI input clock timings for the 31154 133MHz PCI Bridge. [Table 21](#) summarizes the minimum and maximum clock timings at 133, 100, 66, and 33 MHz.

Table 21. Input Clock Timings

Symbol	Parameter	PCI-X 133		PCI-X 100		PCI-X 66		PCI 66		PCI 33		Units	Notes
		Min	Max	Min	Max	Min	Max	Min	Max	Min	Max		
T_{F1}	PCI clock Frequency	100	133	66	100	50	66	33	66	25	33	MHz	Note 1
T_{C1}	PCI clock Cycle Time	7.5	10	10	15	15	20	15	30	30	60	ns	
T_{CH1}	PCI clock High Time	3		3		6		6		11		ns	
T_{CL1}	PCI clock Low Time	3		3		6		6		11		ns	
$TSR1$	PCI clock Slew Rate	1.5	4	1.5	4	1.5	4	1.5	4	1	4	V/ns	Note 2
NOTES: 1- In PCI-33 clock can vary down to DC. Any input below 25MHz must be in PLL bypass mode. 2 -This slew rate as defined in PCI, PCIX specifications The minimum clock period must not be violated for any single clock cycle, i.e., accounting for all system jitter.													

3.8.2 PCI Interface Signal Timings

This section shows the PCI interface signal timings for the 31154 133MHz PCI Bridge. [Table 22](#) summarizes the minimum and maximum signal timings at 133, 100, 66, and 33 MHz.

Table 22. PCI Signal Timings (Sheet 1 of 2)

Symbol	Parameter	PCI-X 133 PCI-X 100		PCI-X 66		PCI 66		PCI 33		Units	Notes
		Min	Max	Min	Max	Min	Max	Min	Max		
T _{OV1}	Clock to Output Valid Delay for bused signals	0.7	3.8	0.7	3.8	1	6	2	11	ns	Notes 1,2,6,7
T _{OV2}	Clock to Output Valid Delay for point to point signals	0.7	3.8	0.7	3.8	2	6	2	12	ns	Notes 1,2,6,7
T _{OF}	Clock to Output Float Delay		7		7		14		28	ns	
T _{IS1}	Input Setup to clock for bused signals	1.2		1.7		3		7		ns	Notes 1,3
T _{IS2}	Input Setup to clock for point to point signals	1.2		1.7		5		10, 12		ns	Notes 1,3
T _{IH1}	Input Hold time from clock	0.5		0.5		0		0		ns	Notes 1,3
T _{RST}	Reset Active Time	1		1		1		1		ms	
T _{RF}	Reset Active to output float delay		40		40		40		40	ns	
T _{IS3}	REQ64# to Reset setup time	10		10		10		10		clocks	Notes 1,3
T _{IH2}	Reset to REQ64# hold time	0	50	0	50	0	50	0	50	ns	Notes 1,3
T _{IS4}	PCI-X initialization pattern to Reset setup time	10		10						clocks	1,3

Table 22. PCI Signal Timings (Sheet 2 of 2)

Symbol	Parameter	PCI-X 133 PCI-X 100		PCI-X 66		PCI 66		PCI 33		Units	Notes
		Min	Max	Min	Max	Min	Max	Min	Max		
T_{IH3}	Reset to PCI-X initialization pattern hold time	0	50	0	50					ns	1,3
NOTES: 1 - See Figure 6 2 - See Figure 7 3 - See Figure 8 4 - See Table 27 5 - See Figure 9 6 - See Figure 10 7 - See Figure 11 8 - See Figure 12											

3.8.3 PCI-X Slew Rates

Table 23 shows the PCI-X slew rates for the 31154 133MHz PCI Bridge.

Table 23. PCI-X Slew Rates

Symbol	Parameter	Condition	Min	Max	Units	Notes
t_r	Output rise slew rate	0.3Vccp to 0.6Vccp	1	4	V/ns	Note 1
t_f	Output fall slew rate	0.6Vccp to 0.3Vccp	1	4	V/ns	Note 1
NOTE: 1 – See Figure 12						

3.8.4 Boundary Scan Test Signal Timings

Table 24 shows the boundary scan test signal timings for the 31154 133MHz PCI Bridge.

Table 24. Boundary Scan Signal Timings (Sheet 1 of 2)

Symbol	Parameter	Min	Max	Units
TBSF	TCK Frequency	0	66	MHz
T_{BSCH}	TCK High Time	7.5		ns
TBSCL	TCK Low Time	7.5		ns
T_{BSCR}	TCK Rise Time		5	ns
T_{BSCF}	TCK Fall Time		5	ns
T_{BSIS1}	Input Setup to TCK	3		ns
T_{BSIH1}	Input Hold from TCK	3		ns
T_{BSOV1}	TDO Output Valid Delay from falling edge of TCK.	1	11	ns

Table 24. Boundary Scan Signal Timings (Sheet 2 of 2)

Symbol	Parameter	Min	Max	Units
T_{OF1}	TDO Output Float Delay from falling edge of TCK.	1	11	ns
	TCK insertion delay.	1.0	3.2	ns
	Boundary Scan clock insertion delay.	1.6	4.8	ns

3.8.5 CMOS General Purpose Interface Timings

Table 25 describes the CMOS general purpose signal timings.

Table 25. CMOS General Purpose Interface Timings

Symbol	Parameter	Min	Max	Units	Notes
T_{OV}	Output Delay Through Pad	0.8	3.25	nsec	Note 1
T_{OF}	Output Float Delay	1.0	3	nsec	Note 1
T_{IS}	Input Delay Through Pad	0.8	2.0	nsec	
T_{IH}	Input Delay Through Pad	0.8	2.0	nsec	
NOTES: 1 – min load 10pf 2 – max load 40pf See Figure 7.					

3.8.6 Bypass Mode Timings

Table 26 describes the bypass mode timings.

Table 26. Bypass Mode Timings

Symbol	Parameter	Min	Max	Units	Notes
T_{OV}	Output Valid Delay. Delay normal timings by 3.3ns.		3.3	ns	1
1 – The bypass clock insertion + delay at the slow corner is about 3.3nS.					

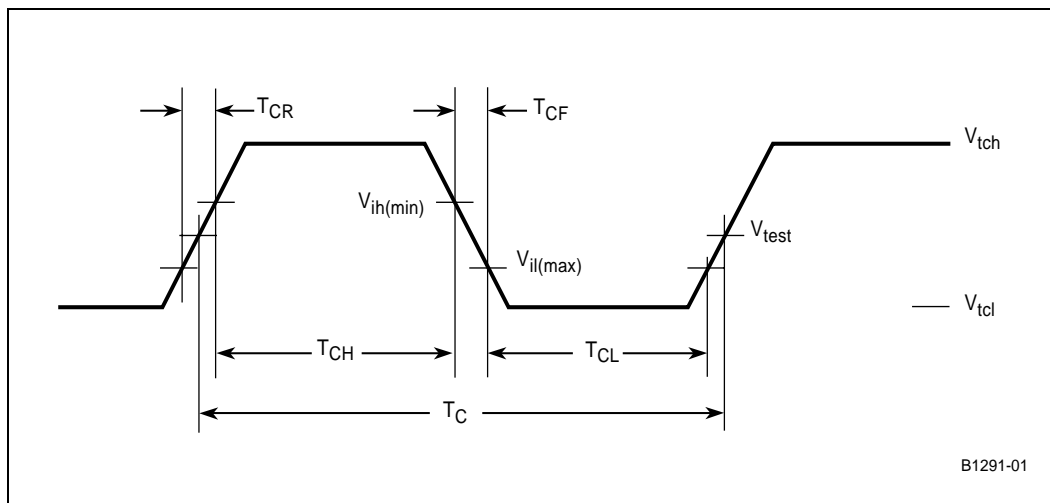
3.9 AC Timing Waveforms

The AC timing waveforms are described in the following sections.

3.9.1 Clock Timing Measurement Waveforms

Figure 6 illustrates the clock timing measurement waveforms.

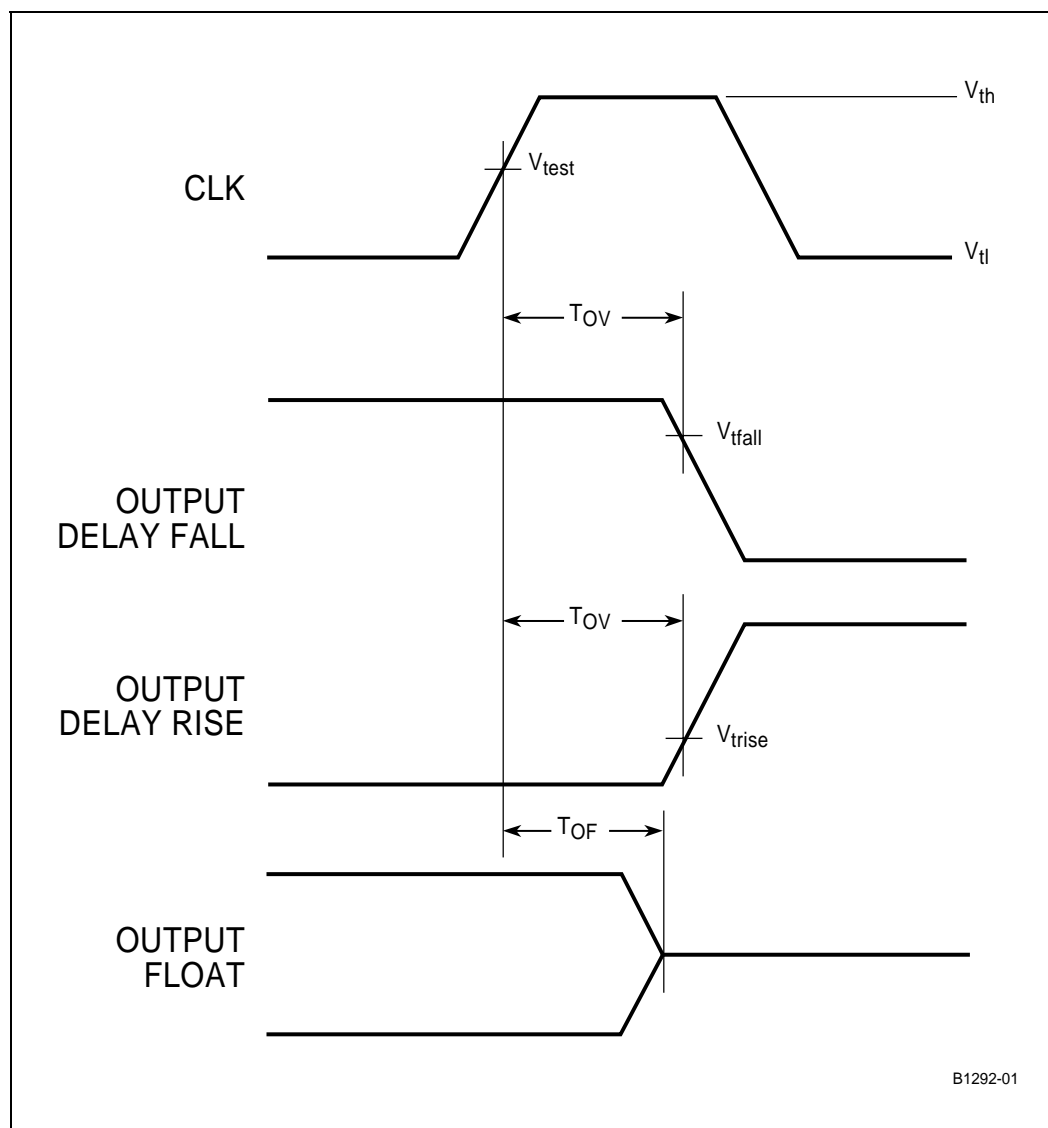
Figure 6. Clock Timing Measurement Waveforms



3.9.2 Output Timing Measurement Waveforms

Figure 7 illustrates the output timing measurement waveforms.

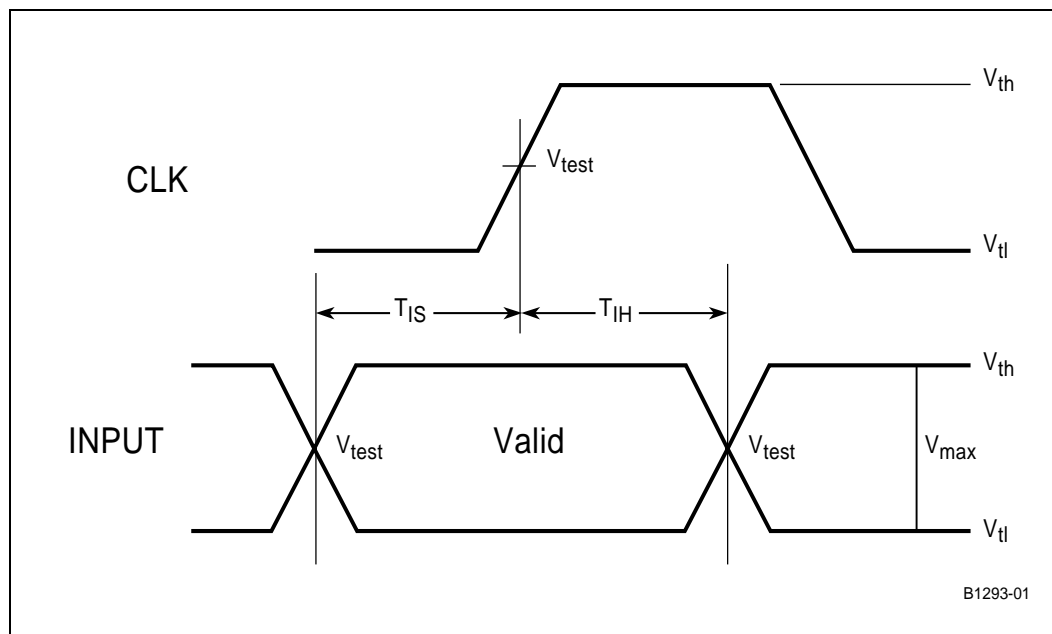
Figure 7. Output Timing Measurement Waveforms



3.9.3 Input Timing Measurement Waveforms

Figure 8 illustrates the input timing measurement waveforms.

Figure 8. Input Timing Measurement Waveforms



3.10 AC Test Conditions

Table 27 lists the AC test loads that are illustrated in the following sections.

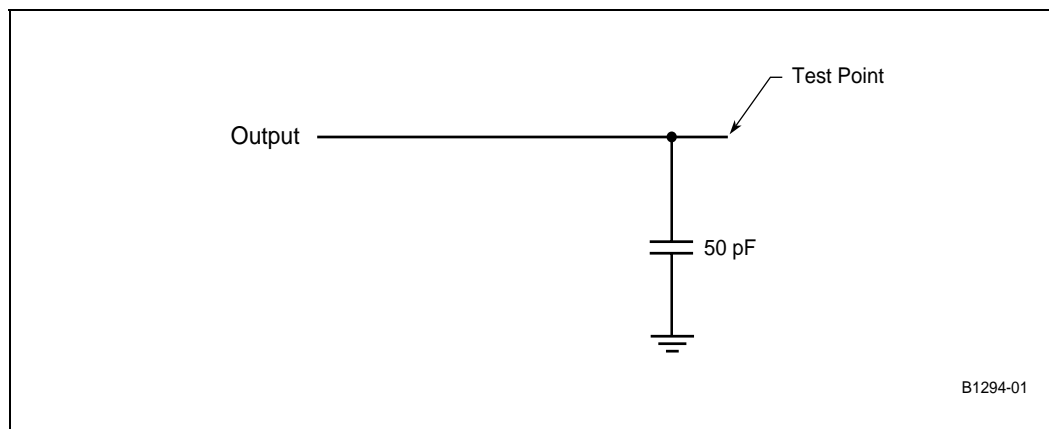
Table 27. AC Measurement Conditions

Symbol	PCI-X	PCI	General IO	Units	Notes
V_{th}	0.6VCCP	0.6VCCP	0.6VCCP	V	
V_{tl}	0.25VCCP	0.2VCCP	0.25VCCP	V	
V_{test}	0.4VCCP	0.4VCCP	0.4VCCP	V	
V_{trise}	0.285VCCP	0.285VCCP	0.285VCCP	V	
V_{tfall}	0.615VCCP	0.615VCCP	0.615VCCP	V	
V_{max}	0.4VCCP	0.4VCCP	0.4VCCP	V	
Slew Rate	1.5	1.5	1.5	V/nS	Note 1
NOTE: 1 – Input signal slew rate is measured between V_{il} and V_{ih}					

3.10.1 AC Test Load for All Signals Except PCI-X

Figure 9. illustrates the AC test load for all signals **except** PCI-X.

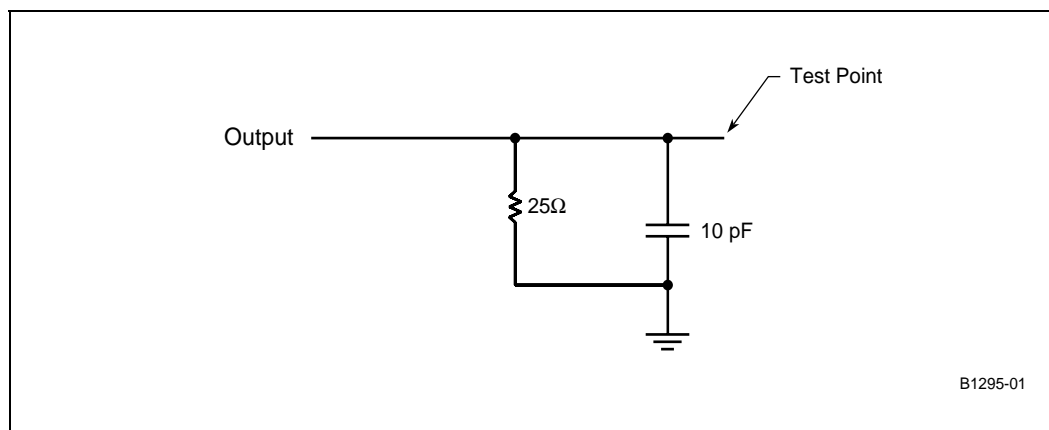
Figure 9. AC Test Load for All Signals Except PCIX



3.10.2 PCI/PCI-X $T_{ov(max)}$ Rising Edge AC Test Load

Figure 10 illustrates the PCI/PCI-X Rising Edge AC test load.

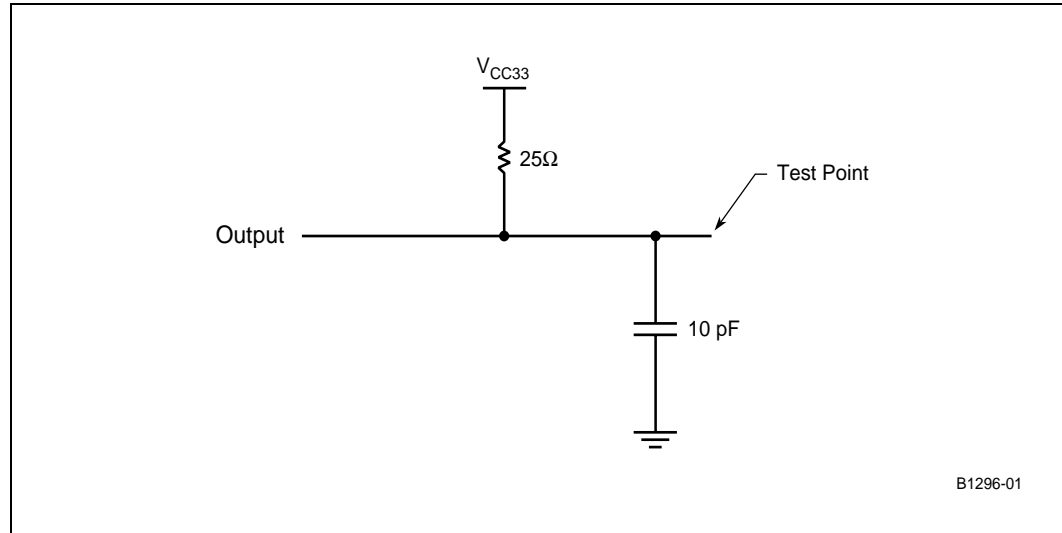
Figure 10. PCI/PCI-X $T_{ov(max)}$ Rising Edge AC Test Load



3.10.3 PCI/PCI-X $T_{ov(max)}$ Falling Edge AC Test Load

Figure 11 illustrates the PCI/PCI-X $T_{ov(max)}$ Falling Edge AC test load.

Figure 11. PCI/PCI-X $T_{ov(max)}$ Falling Edge AC Test Load



3.10.4 PCI/PCI-X $T_{ov(min)}$ AC Test Load

Figure 12 illustrates the PCI/PCI-X $T_{ov(min)}$ test load.

Figure 12. PCI/PCI-X $T_{ov(min)}$ AC Test Load

